

MSB20B-MSB20M

Rev.A Oct.-2023

/ Descriptions

2.0A

UMSB

2.0A Surface Mount Glass Passivated Bridge Rectifier,UMSB thin package.

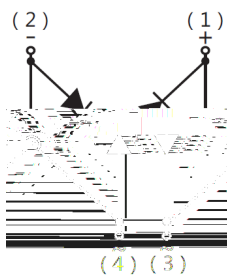
/ Features

Glass Passivated Chip Junction, High Surge Current Capability, Reverse Voltage :100 to 1000V,
Forward Current: 2.0A, Designed for Surface Mount Application,HF product.

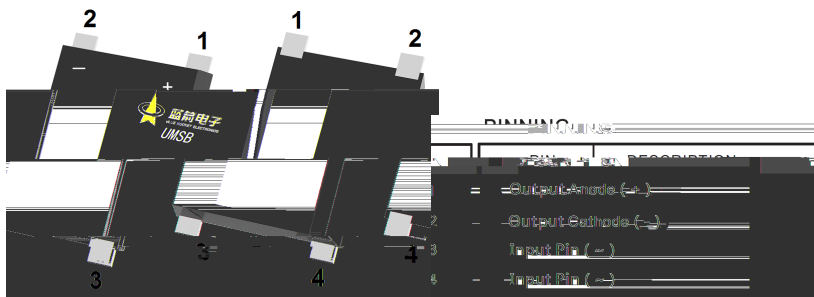
/ Applications

General purpose.

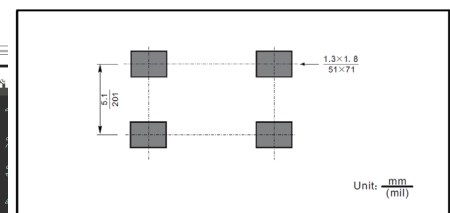
/ Equivalent Circuit



/ Pinning



The recommended mounting pad size



/ Marking

See Marking Instructions.

/ Absolute Maximum Ratings($T_a=25$)

Parameter	Symbol	Rating						Unit
		MSB20B	MSB20D	MSB20G	MSB20J	MSB20K	MSB20M	
Maximum Repetitive Peak Reverse Voltage	V _{RRM}	100	200	400	600	800	1000	V
Maximum RMS voltage	V _{RMS}	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	V _{DC}	100	200	400	600	800	1000	V
Average Rectified Output Current	I _o	2.0						A
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load (JEDEC Method)	I _{FSM}	50						A
Typical Junction Capacitance Note1	C _i	30						pF
Typical Thermal Resistance Note2	R _{θJA} R _{θJC} R _{θJL}	60 10 25						/W
Operating and Storage Temperature Range	T _j , T _{stg}	-55~+150						

Note:

1. Measured at 1MHz and applied reverse voltage of 4 V D.C.
2. Mounted on glass epoxy PC board with 4×1.5"×1.5" 3.81×3.81 cm copper pad.

/ Electrical Characteristics($T_a=25$)

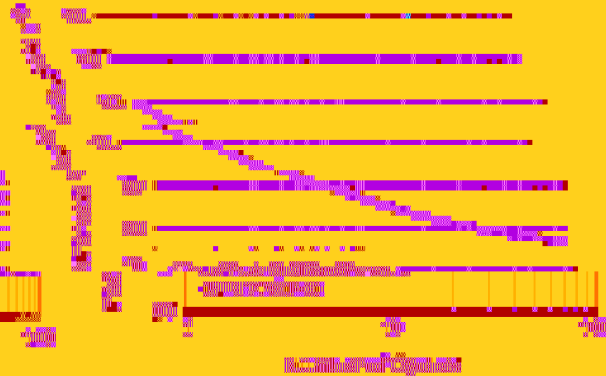
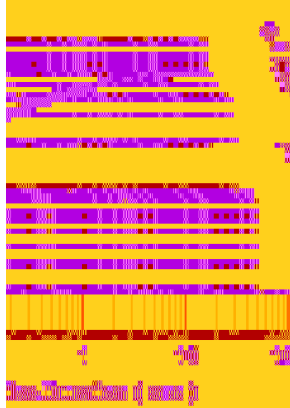
Parameter	Symbol	Test Conditions	Rating	Unit
Maximum Forward Voltage	V_F	$I_F=2.0A$	1.1	V
Maximum DC Reverse Current at Rated DC Blocking Voltage	I_R	$T_a=25$	5	μA
		$T_a=125$	100	

/ Electrical Characteristic Curve

Figure 1. Derating Curve

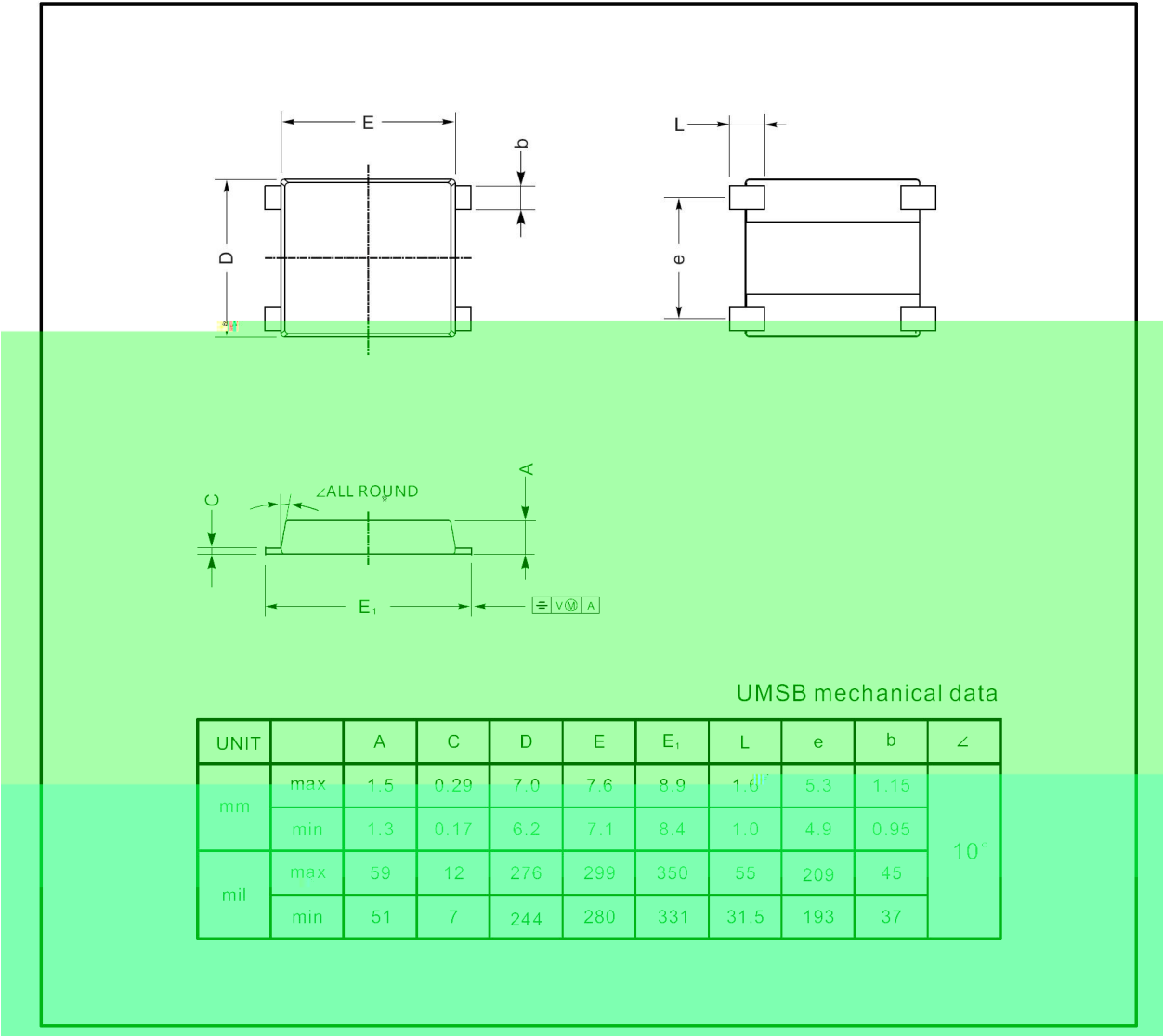


Typical Reverse Characteristics

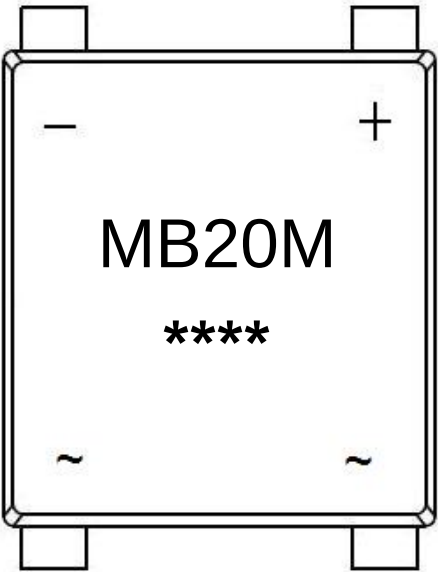


/ Package Dimensions

UMSB



/ Marking Instructions



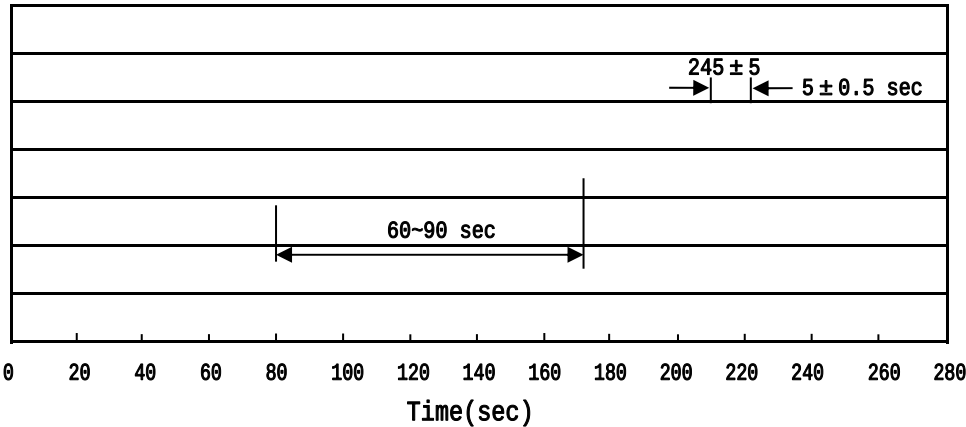
Note:

Product Type Code

Marking

Type number	Marking code
MSB20B	MB20B
MSB20D	MB20D
MSB20G	MB20G
MSB20J	MB20J
MSB20K	MB20K
MSB20M	MB20M

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Note:

- 1

150 180

60 90sec;

1.Preheating:150~180 , Time:60~90sec.
- 2

245 5

5 0.5sec;

2.Peak Temp.:245 5 , Duration:5 0.5sec.
- 3

2 10 /sec.

3. Cooling Speed: 2~10 /sec.

/ Resistance to Soldering Heat Test Conditions

260 5 10 1 sec. Temp.:260±5 Time:10±1 sec

/ Packaging SPEC.

/ REEL

Package Type 7~ E	Units ;> H					Dimension ;> p . (unit /mm³)		
	/ --	-- / -	/ -	- /1ç	/1ç	B	-	1ç
UMSB	3,000	2	6,000	6	36,000	13"×16	337×337×49	380×335×366

/ Notices